

2A, Low Input Voltage, Ultra-Low Dropout Linear Regulator with Enable

General Description

The RT2515A is a high performance positive voltage regulator designed for use in applications requiring ultralow input voltage and ultra-low dropout voltage at up to 2 amperes. It operates with an input voltage as low as 1.4V, with output voltage programmable as low as 0.5V. The RT2515A features ultra low dropout, ideal for applications where output voltage is very close to input voltage. Additionally, the RT2515A has an enable pin to further reduce power dissipation while shutdown. The RT2515A provides excellent regulation over variations in line, load and temperature. The RT2515A is available in the SOP-8 (Exposed Pad) package. The output voltage can be set by an external divider or fixed at 1.2V depending on how the FB pin is configured.

Ordering Information

Package Type
SP: SOP-8 (Exposed Pad-Option 2)

Lead Plating System
G: Green (Halogen Free and Pb Free)

Note:

Richtek products are:

- ▶ RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

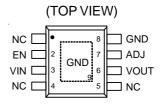
Features

- Input Voltage as Low as 1.4V
- Ultra-Low Dropout Voltage 400mV @ 2A
- Adjustable Output Voltage from 0.5V to 3.8V
- Over Current Protection
- Over Temperature Protection
- 1µA Input Current in Shutdown Mode
- Enable Control
- RoHS Compliant and Halogen Free

Applications

- Telecom/Networking Cards
- Motherboards/Peripheral Cards
- Industrial Applications
- Wireless Infrastructure
- Set Top Box
- Medical Equipment
- Notebook Computers
- Battery Powered Systems

Pin Configurations



SOP-8 (Exposed Pad)

Marking Information



RT2515AGSP: Product Number

YMDNN: Date Code



Typical Application Circuit

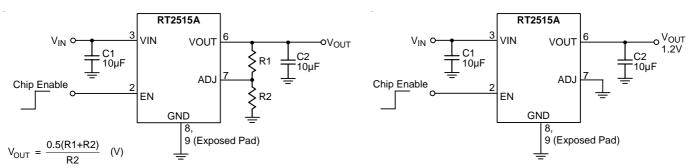


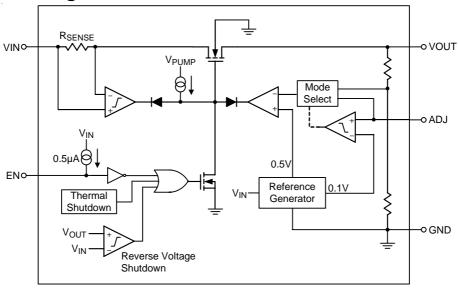
Figure 1. Adjustable Voltage Regulator

Figure 2. Fixed Voltage Regulator

Functional Pin Description

Pin No.	Pin Name	Pin Function		
1, 4, 5	NC	No Internal Connection.		
2	EN	Chip Enable (Active-High). Pulling this pin below 0.4V turns the regulator off, reducing the quiescent current to a fraction of its operating value. The device will be enabled if this pin is left open. Connect to VIN if not being used.		
3	VIN	Input voltage. For regulation at full load, the input to this pin must be between (V_{OUT} + 0.5V) and 5.5V. Minimum input voltage is 1.4V. A large bulk capacitance should be placed closely to this pin to ensure that the input supply does not sag below 1.4V. Also a minimum of $10\mu F$ ceramic capacitor should be placed directly at this pin.		
6	VOUT	Output Voltage. A minimum of 10μF capacitor should be placed directly at this pin.		
7	ADJ	When this pin is grounded, an internal resistor divider sets the output voltage to 1.2V. If connected to the VOUT pin, the output voltage will be set at 0.5V. If external feedback resistors are used, the output voltage will be determined by the resistor ratio.		
8, 9 (Exposed pad)	GND	Ground. The exposed pad must be soldered to a large PCB and connected to GND for maximum power dissipation.		

Function Block Diagram



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Absolute Maximum Ratings (Note 1)

• Supply Voltage, VIN	0.2\/+0.7\/
• Other I/O Pin	- −0.3V to 6V
 Power Dissipation, P_D @ T_A = 25°C 	
SOP-8 (Exposed Pad)	- 2.04W
Package Thermal Resistance (Note 2)	
SOP-8 (Exposed Pad), θ_{JA}	- 49°C/W
SOP-8 (Exposed Pad), θ_{JC}	· 15°C/W
• Lead Temperature (Soldering, 10 sec.)	· 260°C
• Junction Temperature	· 150°C
Storage Temperature Range	-65°C to 150°C
ESD Susceptibility (Note 3)	
HBM (Human Body Model)	· 2kV
Recommended Operating Conditions (Note 4)	

• Supply Voltage, VIN	1.4V to 6V
Junction Temperature Range	-40°C to 125°C
Ambient Temperature Range	-40°C to 85°C

Electrical Characteristics

(V_{IN} = 1.4V to 6V, I_{OUT} = 10 μ A to 2A, V_{ADJ} = V_{OUT}, -40° C \leq T_A \leq 85 $^{\circ}$ C, unless otherwise specified)

Parameter	Symbol	Test Conditions		Тур	Max	Unit	
Quiescent Current	IQ	V _{IN} = 3.3V, I _{OUT} = 0A		0.7	1.5	mA	
Shutdown Current	I _{SHDN}	V _{IN} = 5.5V, V _{EN} = 0V		1.5	10	μА	
Output Voltage (Fixed Output, V _{ADJ} = 0V)	Vout	$V_{IN} = V_{OUT} + 0.5V$, $I_{OUT} = 10$ mA $T_A = 25$ °C $V_{IN} = 1.8V$, $I_{OUT} = 0.8A$, $T_A = 25$ °C	-2 2		2	%	
, , , , , ,		$1.4V \le V_{IN} \le 5.5V$, $I_{OUT} = 10mA$	-3		3		
Line Regulation	ΔV_{LINE}	I _{OUT} = 10mA		0.2	0.4	%/V	
Load Regulation	ΔV_{LOAD}	I _{OUT} = 10mA to 2A		0.5	1.5	%	
		I _{OUT} = 1A, V _{IN} ≥ 1.6V		120	200		
		I _{OUT} = 1A, 1.4V < V _{IN} < 1.6V			400		
Dronout Voltage	V _{DROP}	I _{OUT} = 1.5A, V _{IN} ≥ 1.6V		180	300	mV	
Dropout Voltage		I _{OUT} = 1.5A, 1.4V < V _{IN} < 1.6V			500		
		I _{OUT} = 2A, V _{IN} ≥ 1.6V		240	400		
		I _{OUT} = 2A, 1.4V < V _{IN} < 1.6V			600		
Current Limit	I _{LIM}	V _{IN} = 3.3V	2.3	3	4.4	Α	

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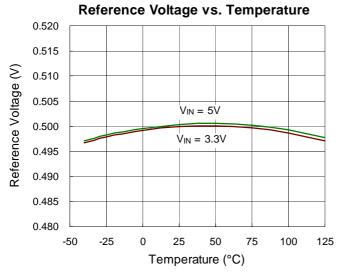
Parameter		Symbol	Test Conditions	Min	Тур	Max	Unit
Feedback							
ADJ Reference Voltage		V _{ADJ}	$V_{IN} = 3.3V$, $V_{ADJ} = V_{OUT}$, $I_{OUT} = 10$ mA, $T_A = 25$ °C	0.495		0.505	V
		VADJ	$V_{IN} = 3.3V$, $V_{ADJ} = V_{OUT}$, $I_{OUT} = 10$ mA	0.49		0.51	
ADJ Pin Current		I _{ADJ}	V _{ADJ} = 0.5V		20	200	nA
ADJ Pin Thresho	ADJ Pin Threshold		V _{IN} = 3.3V	0.05	0.1	0.15	V
ADJ Pin Threshold V_{TH_ADJ} $V_{IN} = 3.3V$ 0.05 0.1 0.15 V Enable							
EN Pin Current		I _{EN}	V _{EN} = 0V, V _{IN} = 5.5V		1	10	μΑ
EN Threshold Voltage	Logic-High	V _{IH}	V _{IN} = 3.3V	1.6			V
	Logic-Low	V _{IL}	V _{IN} = 3.3V			0.4	
Over Temperature Protection							
OTP Trip Level					160		°C
Hysteresis					30		°C

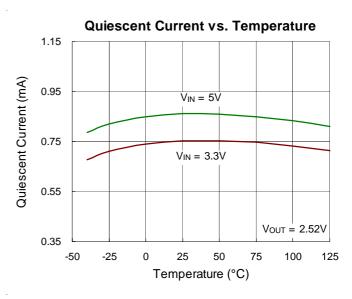
- Note 1. Stresses beyond those listed "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
- Note 2. θ_{JA} is measured at $T_A = 25^{\circ}C$ on a high effective thermal conductivity four-layer test board per JEDEC 51-7. θ_{JC} is measured at the exposed pad of the package.
- Note 3. Devices are ESD sensitive. Handling precaution is recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.

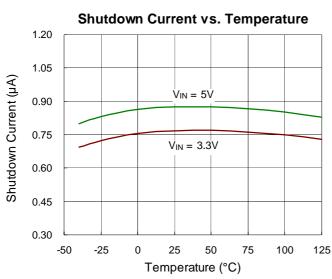
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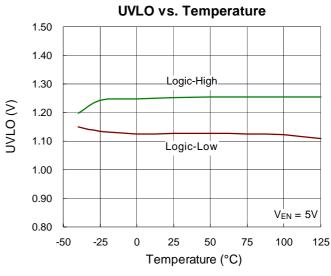


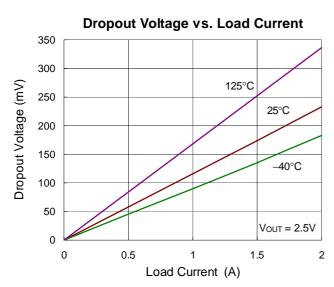
Typical Operating Characteristics

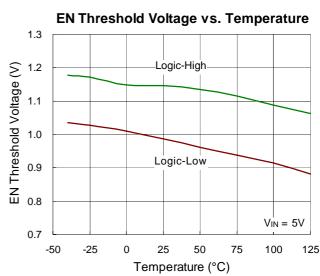








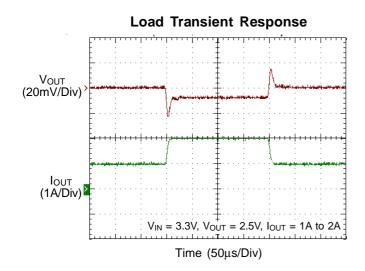


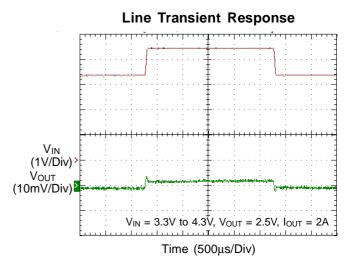


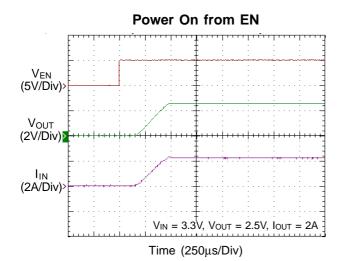
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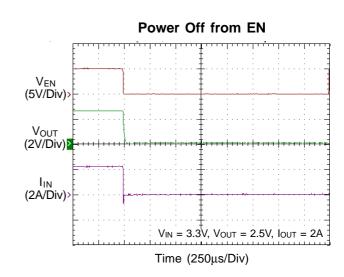
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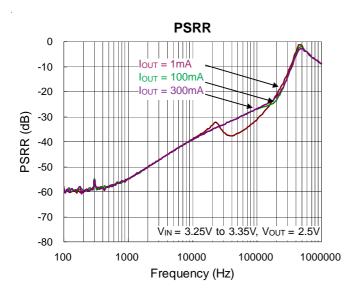














Application Information

The RT2515A is a low voltage, low dropout linear regulator with an external bias supply input capable of supporting an input voltage range from 1.4V to 6V with a fixed output voltage from 1V to 2V in 0.1V increments.

Output Voltage Setting

The RT2515A output voltage is adjustable from 1.4V to 6V via the external resistive voltage divider. The voltage divider resistors can have values of up to $800k\Omega$ because of the very high impedance and low bias current of the sense comparator. The output voltage is set according to the following equation:

$$V_{OUT} = V_{ADJ} \times \left(1 + \frac{R1}{R2}\right)$$

where V_{ADJ} is the reference voltage with a typical value of 0.5V.

Chip Enable Operation

The RT2515A goes into sleep mode when the EN pin is in a logic low condition. In this condition, the pass transistor, error amplifier, and band gap are all turned off, reducing the supply current to only 10µA (max.). The EN pin can be directly tied to VIN to keep the part on.

Current Limit

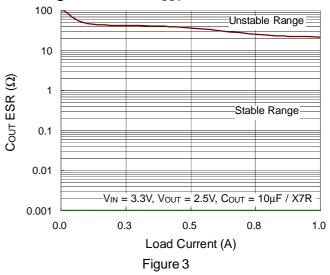
The RT2515A contains an independent current limit circuitry, which monitors and controls the pass transistor's gate voltage, limiting the output current to 3A (typ.).

CIN and COUT Selection

Like any low dropout regulator, the external capacitors of the RT2515A must be carefully selected for regulator stability and performance. Using a capacitor of at least 10μF is suitable. The input capacitor must be located at a distance of not more than 0.5 inch from the input pin of the IC. Any good quality ceramic capacitor can be used. However, a capacitor with larger value and lower ESR (Equivalent Series Resistance) is recommended since it will provide better PSRR and line transient response.

The RT2515A is designed specifically to work with low ESR ceramic output capacitor for space saving and performance consideration. Using a ceramic capacitor with capacitance of at least $10\mu F$ and ESR larger than $1m\Omega$ on the RT2515A output ensures stability. Nevertheless, the RT2515A can still work well with other types of output capacitors due to its wide range of stable ESR. Figure 3 shows the allowable ESR range as a function of load current for various output capacitance. Output capacitors with larger capacitance can reduce noise and improve load transient response, stability, and PSRR. The output capacitor should be located at a distance of not more than 0.5 inch from the output pin of the RT2515A.





Thermal Considerations

Thermal protection limits power dissipation in RT2515A. When the operation junction temperature exceeds 160°C, the OTP circuit starts the thermal shutdown function and turns the pass element off. The pass element turns on again after the junction temperature cools by 30°C.

RT2515A output voltage will be closed to zero when output short circuit occurs as shown in Figure 4. It can reduce the IC temperature and provides maximum safety to end users when output short circuit occurs.

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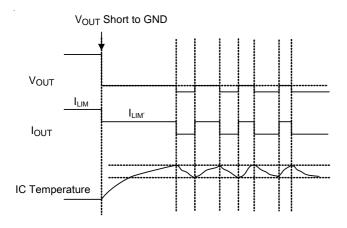


Figure 4. Short Circuit Protection when Output Short Circuit Occurs

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction to ambient thermal resistance.

For recommended operating condition specifications, the maximum junction temperature is 125°C. The junction to ambient thermal resistance, θ_{JA} , is layout dependent. For SOP-8 (Exposed Pad) package, the thermal resistance, θ_{JA} , is 49°C/W on a standard JEDEC 51-7 four-layer thermal test board. The maximum power dissipation at T_A = 25°C can be calculated by the following formula:

$$P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / 49^{\circ}C/W) = 2.04W$$
 for

SOP-8 (Exposed Pad) package

The maximum power dissipation depends on the operating ambient temperature for fixed $T_{J(MAX)}$ and thermal resistance, θ_{JA} . The derating curve in Figure 5 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

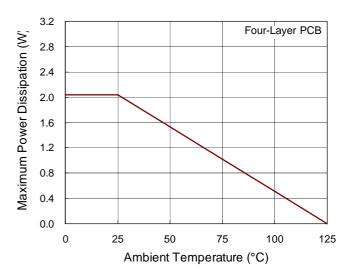
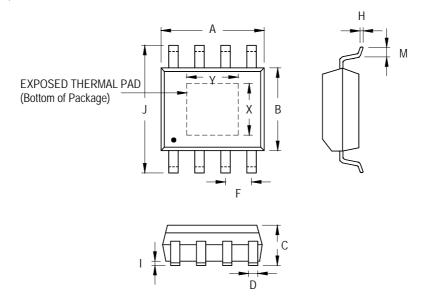


Figure 5. Derating Curve of Maximum Power Dissipation



Outline Dimension



Symbol		Dimensions I	n Millimeters	Dimensions In Inches		
		Min	Max	Min	Max	
А		4.801	5.004	0.189	0.197	
В		3.810	4.000	0.150	0.157	
С		1.346	1.753	0.053	0.069	
D		0.330	0.510	0.013	0.020	
F		1.194	1.346	0.047	0.053	
Н		0.170	0.254	0.007	0.010	
1		0.000	0.152	0.000	0.006	
J		5.791	6.200	0.228	0.244	
М		0.406	1.270	0.016	0.050	
Ontion 1	Х	2.000	2.300	0.079	0.091	
Option 1	Υ	2.000	2.300	0.079	0.091	
Option 2	Х	2.100	2.500	0.083	0.098	
Option 2	Υ	3.000	3.500	0.118	0.138	

8-Lead SOP (Exposed Pad) Plastic Package

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